

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hyung Joon KIM	04/22/2011
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.
Street Address:	314 Maetan 3-dong, Yeongtong-gu, Suwon,
City:	Gyeonggi-do
State/Country:	REPUBLIC OF KOREA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13283835
CORRESPONDENCE DATA	
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Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20005-3096
ATTORNEY DOCKET NUMBER:	069576-0970
NAME OF SUBMITTER:	Stephen A. Becker/ksa
Total Attachments: 2 source=0695760970assigntransmittal#page1.tif source=0695760970assign#page1.tif	

CH \$40.00 13283835

RECORDATION FORM COVER SHEET

Docket No.: 069576-0970

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Hyung Joon KIM

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): **April 22, 2011**

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License

2. Name and address of receiving party(ies)

Name: **SAMSUNG ELECTRO-MECHANICS CO., LTD.**

Internal Address:

Address: **314 Maetan 3-dong, Yeongtong-gu, Suwon, Gyunggi-do, Republic of Korea**

4. Application or patent number(s):

A. Patent Application No(s).

This document is being filed together with a new application.

B. Patent No(s).

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP
 Internal Address:
 Street Address: 600 13th Street, N.W.
 City: Washington, State: DC Zip: 20005-3096
 D.C.
 Phone Number: 202.756.8000
 Fax Number: 202.756.8087
 Email Address: mweipdocket@mwe.com

6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information:

a. Credit Card Last 4 Numbers _____
 Expiration Date _____
 b. Deposit Account Number 500417
 Authorized User Name _____

9. Signature.

Stephen A. Becker 26,527



October 28, 2011

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: **2**

(SAB)

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) KIM, Hyung Joon (5) _____
- (2) _____ (6) _____
- (3) _____ (7) _____
- (4) _____ (8) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto
SAMSUNG ELECTRO-MECHANICS CO., LTD.
314 Maetan 3-dong, Yeongtong-gu, Suwon, Gyunggi-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled MULTILAYER CERAMIC CAPACITOR AND METHOD OF MANUFACTURING THE SAME

(a) for which an application for United States Letters Patent was filed on _____ and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____, and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

1) Kim Hyung Joon 2011. 4. 22
 Name: KIM, Hyung Joon

PATENT